

JUN 22 2005

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Application Serial No. .... 10/620,468  
Filing Date ..... July 15, 2003  
Inventor ..... Dinesh Chopra  
Assignee ..... Micron Technology, Inc.  
Group Art Unit ..... 2822  
Examiner ..... T. Tran  
Attorney's Docket No. .... MI22-2345  
Title: Conductive Connection Forming Methods, Oxidation Reducing Methods,  
and Integrated Circuits Formed Thereby

SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT


The Examiner's attention is directed to the references which are listed on the attached Form PTO-1449. No admission is made regarding whether the submitted reference is prior art.

Citation of these references is respectfully requested.

Respectfully submitted,

Dated: 22 Jun 2005

By:

  
James E. Lake  
Reg. No. 44,854

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Form PTO-1449		U.S. DEPARTMENT OF COMMERCE PATENT AND TRADEMARK OFFICE			ATTY. DOCKET NO. MI22-2345		SERIAL NO. 10/620,488	
LIST OF ART CITED BY APPLICANT <small>(Use several sheets if necessary)</small>					APPLICANT: Dinesh Chopra			
					FILING DATE July 15, 2003		GROUP 2822	
<b>U.S. PATENT DOCUMENTS</b>								
Examiner's Initials	AA	Document Number	Date	Name	Class	Subclass	Filing Date If Appropriate	
	AA	6,172,421	01/2001	Besser et al.	257	751		
	AB	6,444,567	09/2002	Besser	438	625		
	AC							
	AD							
	AE							
	AF							
	AG							
	AH							
	AI							
<b>FOREIGN PATENT DOCUMENTS</b>								
		Document Number	Date	Country	Class	Subclass	Translation	
							Yes	No
	AJ							
	AK							
	AL							
<b>OTHER REFERENCES (including Author, Title, Date, Pertinent Pages, Etc.)</b>								
	AM							
	AN							
	AO							
EXAMINER		DATE CONSIDERED						
<small>*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.</small>								